

Datasheet revision 1.2 www.chipquik.com

Solder Wire Sn63/Pb37 No-Clean with 2.0% Flux Core 0.3oz Tube

Product Highlights

No-Clean Synthetic Flux Core

The clear, non-corrosive, non-conductive residue is meant to be left on the board.

2.0% flux core

Halogen content: None

Specifications

Alloy: Sn63/Pb37 Wire Diameter: 0.020" (0.5mm) Flux Type: No-Clean Synthetic

Flux Classification: ROL0

183°C (361°F) Melting Point: Packaging: 0.3oz Tube Shelf Life: >60 months



Test Results

| Test J-STD-004 or other requirements as stated | Test Requirement | Result |
|--|---|--|
| Copper Mirror | IPC-TM-650: 2.3.32 | L: No breakthrough |
| Corrosion | IPC-TM-650: 2.6.15 | L: No corrosion |
| Quantitative Halides | IPC-TM-650: 2.3.28.1 | L: <0.05% |
| Electrochemical Migration | IPC-TM-650: 2.6.14.1 | L: <1 decade drop (No-clean) |
| Surface Insulation Resistance 85°C, 85% RH @ 168 Hours | IPC-TM-650: 2.6.3.7 | L: ≥100MΩ (No-clean) |
| Visual | IPC-TM-650: 3.4.2.5 | Clear and free from precipitation |
| Conflict Minerals Compliance | Electronic Industry Citizenship Coalition (EICC) | Compliant |
| REACH Compliance | Articles 33 and 67 of Regulation (EC) No 1907/2006 | Contains Lead (Pb) CAS# 7439-92-1 No other SVHC present |
| | | |

Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes): Yes

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes No

RoHS 3 Directive (EU) 2015/863: